

DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled METHOD AND APPARATUS FOR FORMING AND HERMETICALLY SEALING SLICES OF FOOD ITEMS, the specification of which:

\_\_\_\_\_ is attached hereto.

X was filed on November 12, 1991 as Application Serial No. 07/791,490

\_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)Priority Claimed

(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
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I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(Status-patented, pending, abandoned)
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Inventor's Signature

Full name of sole or first inventor

Residence

Citizenship

Post Office Address

Vincent A. Meli Date 12-27-91  
Green Bay, WI  
U.S.  
4452 Wyandot Trail  
Green Bay, WI

Inventor's Signature

Full name of second joint inventor, if any

Residence

Citizenship

Post Office Address

Michael A. Matharani Date Dec. 27, 1991  
DePere, WI  
U.S.  
721 N. Broadway  
DePere, WI 54115

WILLIAM BRINKS OLDS HOFER GILSON & LIONE  
P.O. Box 10395  
Chicago, IL 60610  
(312) 321-4200

Inventor's Signature

Full name of third joint inventor 300

Residence

Citizenship

Post Office Address

Ted A. Brzezinski Date 12/27/91  
Ted A. Brzezinski  
Green Bay, WI  
U.S.  
1453 Bruce Lane  
Green Bay, WI 54303

Inventor's Signature

Full name of fourth joint inventor 400

Residence

Citizenship

Post Office Address

David L. Shaft Date 12/27/91  
David L. Shaft  
Green Bay, WI  
U.S.  
2868 St. Anthony Drive  
Green Bay, WI 54311

Inventor's Signature

Full name of fifth joint inventor 500

Residence

Citizenship

Post Office Address

James L. Urmanowski Date 12/27/91  
James L. Urmanowski  
Green Bay, WI  
U.S.  
515 Dauphin Street  
Green Bay, WI 54301

Inventor's Signature

Full name of sixth joint inventor

Residence

Citizenship

Post Office Address

Date